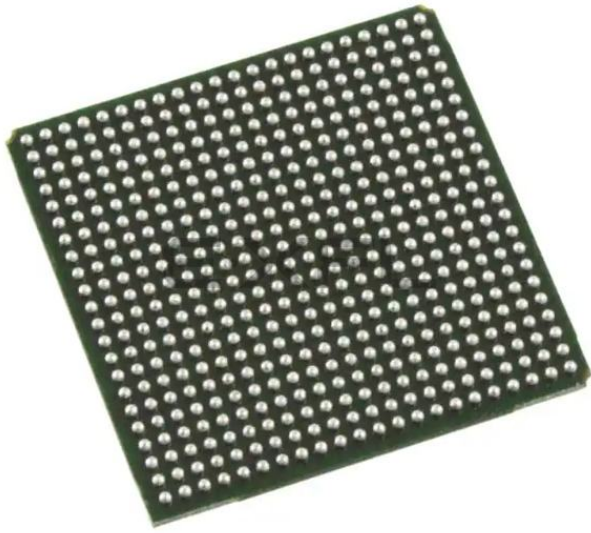




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Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	4000
Number of Logic Elements/Cells	32000
Total RAM Bits	339968
Number of I/O	331
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-35se-5fn484i

Architecture Overview

Each LatticeECP2/M device contains an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM™ Embedded Block RAM (EBR) and rows of sys-DSP™ Digital Signal Processing blocks, as shown in Figure 2-1. In addition, the LatticeECP2M family contains SERDES Quads in one or more of the corners. Figure 2-2 shows the block diagram of ECP2M20 with one quad.

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional Unit without RAM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM and ROM functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row.

The LatticeECP2/M devices contain one or more rows of sysMEM EBR blocks. sysMEM EBRs are large dedicated 18K fast memory blocks. Each sysMEM block can be configured in a variety of depths and widths of RAM or ROM. In addition, LatticeECP2/M devices contain up to two rows of DSP Blocks. Each DSP block has multipliers and adder/accumulators, which are the building blocks for complex signal processing capabilities.

The LatticeECP2M devices feature up to 16 embedded 3.125Gbps SERDES (Serializer / Deserializer) channels. Each SERDES channel contains independent 8b/10b encoding / decoding, polarity adjust and elastic buffer logic. Each group of four SERDES channels along with its Physical Coding Sub-layer (PCS) block, creates a quad. The functionality of the SERDES/PCS Quads can be controlled by memory cells set during device configuration or by registers that are addressable during device operation. The registers in every quad can be programmed by a soft IP interface, referred to as the SERDES Client Interface (SCI). These quads (up to four) are located at the corners of the devices.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysI/O buffers. The sysI/O buffers of the LatticeECP2/M devices are arranged in eight banks, allowing the implementation of a wide variety of I/O standards. In addition, a separate I/O bank is provided for the programming interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. The PIC logic also includes pre-engineered support to aid in the implementation of high speed source synchronous standards such as SPI4.2, along with memory interfaces including DDR2.

The LatticeECP2/M registers in PFU and sysI/O can be configured to be SET or RESET. After power up and the device is configured, it enters into user mode with these registers SET/RESET according to the configuration setting, allowing the device entering to a known state for predictable system function.

Other blocks provided include PLLs, DLLs and configuration functions. The LatticeECP2/M architecture provides two General PLLs (GPLL) and up to six Standard PLLs (SPLL) per device. In addition, each LatticeECP2/M family member provides two DLLs per device. The GPLLs and DLLs blocks are located in pairs at the end of the bottom-most EBR row; the DLL block is located towards the edge of the device. The SPLL blocks are located at the end of the other EBR/DSP rows.

The configuration block that supports features such as configuration bit-stream decryption, transparent updates and dual boot support is located toward the center of this EBR row. The Ball Grid Array (BGA) package devices in the LatticeECP2/M family supports a sysCONFIG™ port located in the corner between banks four and five, which allows for serial or parallel device configuration.

In addition, every device in the family has a JTAG port. This family also provides an on-chip oscillator. The LatticeECP2/M devices use 1.2V as their core voltage.

Table 2-12. PIO Signals List

Name	Type	Description
CE0, CE1	Control from the core	Clock enables for input and output block flip-flops
CLK0, CLK1	Control from the core	System clocks for input and output blocks
ECLK1, ECLK2	Control from the core	Fast edge clocks
LSR	Control from the core	Local Set/Reset
GSRN	Control from routing	Global Set/Reset (active low)
INCK ²	Input to the core	Input to Primary Clock Network or PLL reference inputs
DQS	Input to PIO	DQS signal from logic (routing) to PIO
INDD	Input to the core	Unregistered data input to core
INFF	Input to the core	Registered input on positive edge of the clock (CLK0)
IPOS0, IPOS1	Input to the core	Double data rate registered inputs to the core
QPOS0 ¹ , QPOS1 ¹	Input to the core	Gearbox pipelined inputs to the core
QNEG0 ¹ , QNEG1 ¹	Input to the core	Gearbox pipelined inputs to the core
OPOS0, ONEG0, OPOS2, ONEG2	Output data from the core	Output signals from the core for SDR and DDR operation
OPOS1 ONEG1	Tristate control from the core	Signals to Tristate Register block for DDR operation
DEL[3:0]	Control from the core	Dynamic input delay control bits
TD	Tristate control from the core	Tristate signal from the core used in SDR operation
DDRCLKPOL	Control from clock polarity bus	Controls the polarity of the clock (CLK0) that feed the DDR input block
DQSXFER	Control from core	Controls signal to the Output block

1. Signals available on left/right/bottom only.

2. Selected I/O.

PIO

The PIO contains four blocks: an input register block, output register block, tristate register block and a control logic block. These blocks contain registers for operating in a variety of modes along with the necessary clock and selection logic.

Input Register Block

The input register blocks for PIOs in left, right and bottom edges contain delay elements and registers that can be used to condition high-speed interface signals, such as DDR memory interfaces and source synchronous interfaces, before they are passed to the device core. Figure 2-29 shows the diagram of the input register block for left, right and bottom edges. The input register block for the top edge contains one memory element to register the input signal as shown in Figure 2-30. The following description applies to the input register block for PIOs in the left, right and bottom edges of the device.

Input signals are fed from the sysI/O buffer to the input register block (as signal DI). If desired, the input signal can bypass the register and delay elements and be used directly as a combinatorial signal (INDD), a clock (INCK) and, in selected blocks, the input to the DQS delay block. If an input delay is desired, designers can select either a fixed delay or a dynamic delay DEL[3:0]. The delay, if selected, reduces input register hold time requirements when using a global clock.

The input block allows three modes of operation. In the single data rate (SDR) the data is registered, by one of the registers in the single data rate sync register block, with the system clock. In DDR Mode, two registers are used to sample the data on the positive and negative edges of the DQS signal, creating two data streams, D0 and D1. These two data streams are synchronized with the system clock before entering the core. Further discussion on this topic is in the DDR Memory section of this data sheet.

O standards (together with their supply and reference voltages) supported by LatticeECP2/M devices. For further information about utilizing the sysI/O buffer to support a variety of standards please see the the list of additional technical information at the end of this data sheet.

Table 2-13. Supported Input Standards

Input Standard	V _{REF} (Nom.)	V _{CCIO} ¹ (Nom.)
Single Ended Interfaces		
LVTTL	—	—
LVC MOS33	—	—
LVC MOS25	—	—
LVC MOS18	—	1.8
LVC MOS15	—	1.5
LVC MOS12	—	—
PCI 33	—	3.3
HSTL18 Class I, II	0.9	—
HSTL15 Class I	0.75	—
SSTL3 Class I, II	1.5	—
SSTL2 Class I, II	1.25	—
SSTL18 Class I, II	0.9	—
Differential Interfaces		
Differential SSTL18 Class I, II	—	—
Differential SSTL2 Class I, II	—	—
Differential SSTL3 Class I, II	—	—
Differential HSTL15 Class I	—	—
Differential HSTL18 Class I, II	—	—
LVDS, MLVDS, LVPECL, BLVDS, RSDS	—	—

¹ When not specified, V_{CCIO} can be set anywhere in the valid operating range (page 3-1).

PCI Express Electrical and Timing Characteristics

AC and DC Characteristics

Table 3-16. Transmit^{1, 2}

Symbol	Description	Test Conditions	Min	Typ	Max	Units
UI	Unit interval		399.88	400	400.12	ps
V _{TX-DIFF_P-P}	Differential peak-to-peak output voltage		0.8	1.0	1.2	V
V _{TX-DE-RATIO}	De-emphasis differential output voltage ratio		0	-3.5	-7.96	dB
V _{TX-CM-AC_P}	RMS AC peak common-mode output voltage		—	20	—	mV
V _{TX-CM-DC-LINE-DELTA}	Maximum Common mode voltage delta between n and p channels		—	—	25	mV
V _{TX-DC-CM}	Tx DC common mode voltage		0	—	V _{CCOB} + 5%	V
I _{TX-SHORT}	Output short circuit current	V _{TX-D+} =0.0V V _{TX-D-} =0.0V	—	—	90	mA
Z _{TX-DIFF-DC}	Differential output impedance		80	100	120	Ohms
T _{TX-RISE}	Tx output rise time	20 to 80%	0.125	—	—	UI
T _{TX-FALL}	Tx output fall time	20 to 80%	0.125	—	—	UI
L _{TX-SKEW}	Lane-to-lane static output skew for all lanes in port/link		—	—	1.3	ns
T _{TX-EYE}	Transmitter eye width		0.75	—	—	UI
T _{TX-EYE-MEDIAN-TO-MAX-JITTER} ³			—	—	0.125	UI
C _{TX}	AC coupling capacitor		75	—	200	nF

1. Values are measured at 2.5 Gbps.

2. Compliant to PCI Express v1.1.

3. Measured at 60ps with plug-in board and jitter due to socket removed.

Table 3-17. Receive

Symbol	Description	Test Conditions	Min.	Typ.	Max.	Units
UI	Unit Interval		399.88	400	400.12	ps
V _{RX-DIFF_P-P}	Differential peak-to-peak input voltage		0.175	—	—	V
V _{RX-IDLE-DET-DIFF_P-P}	Idle detect threshold voltage		65	—	175	mV
Z _{RX-DIFF-DC}	DC differential input impedance		80	100	120	Ohms
Z _{RX-DC}	DC input impedance		40	50	60	Ohms
Z _{RX-HIGH-IMP-DC} ¹	Power-down DC input impedance		200K	—	—	Ohms
T _{RX-EYE}	Receiver eye width		0.4	—	—	UI
T _{RX-EYE-MEDIAN-TO-MAX-JITTER}			—	—	0.3	UI

Notes:

1. Measured with external AC-coupling on the receiver

2. Values are measured at 2.5 Gbps

LatticeECP2/M sysCONFIG Port Timing Specifications (Continued)

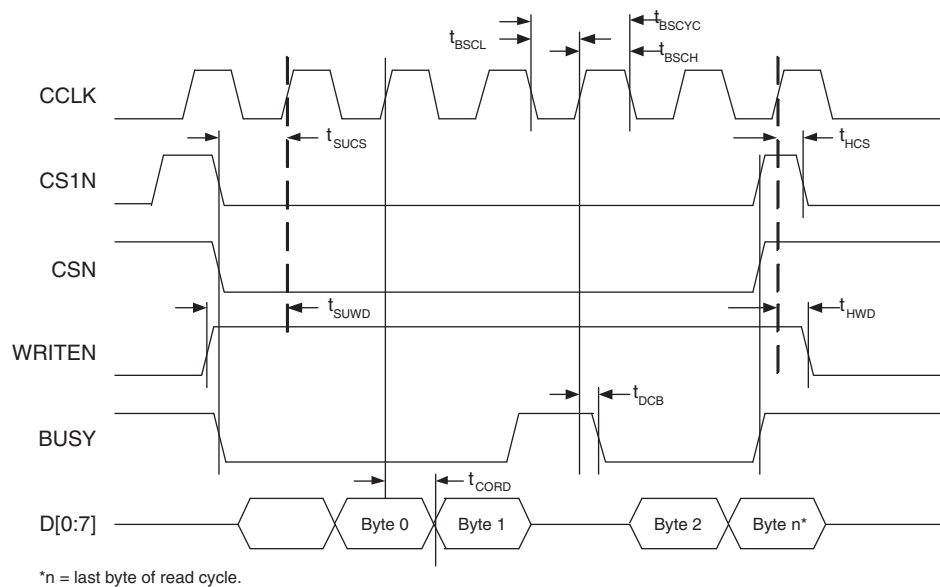
Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
f_{MAXSPI}	Max. CCLK Frequency - SPI Flash Read Opcode (0x03) (SPIFASTN = 1)	—	20	MHz
	Max. CCLK Frequency - SPI Flash Fast Read Opcode (0x0B) (SPIFASTN = 0)	—	50	MHz
	Max. CCLK Frequency - Encrypted Bitstream	—	10	MHz
t_{SUSPI}	SOSPI Data Setup Time Before CCLK	7	—	ns
t_{HSPI}	SOSPI Data Hold Time After CCLK	2	—	ns
t_{SUMCDI}	DI Setup to CCLK	7	—	ns
t_{HMCDI}	DI Hold from CCLK	1	—	ns

1. Re-toggling the PROGRAMN pin is not permitted until the INITN pin is high. Avoid consecutive toggling of the PROGRAMN.
2. For SED (Soft Error Detect), the SEDCLKIN operating frequency must be at least 20MHz. SEDCLKIN is derived from Master Clock Frequency that has a +/-30% variation..

Parameter	Min.	Max.	Units
Master Clock Frequency	Selected value - 30%	Selected value + 30%	MHz
Duty Cycle	40	60	%

Figure 3-14. sysCONFIG Parallel Port Read Cycle



LatticeECP2 Pin Information Summary, LFE2-6 and LFE2-12

Pin Type		LFE2-6		LFE2-12			
		144 TQFP	256 fpBGA	144 TQFP	208 PQFP	256 fpBGA	484 fpBGA
Single Ended User I/O		90	190	93	131	193	297
Differential Pair User I/O		43	95	45	62	96	148
Configuration	TAP Pins	5	5	5	5	5	5
	Muxed Pins	14	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7	7
Non Configuration	Muxed Pins	34	54	33	40	54	57
	Dedicated Pins	3	3	3	3	3	3
VCC		10	7	10	14	7	16
VCCAUX		4	4	4	8	4	16
VCCPLL		0	0	0	0	0	0
VCCIO	Bank0	1	2	1	2	2	4
	Bank1	1	2	1	2	2	4
	Bank2	1	2	1	2	2	4
	Bank3	1	2	1	2	2	4
	Bank4	1	2	1	2	2	4
	Bank5	1	2	1	2	2	4
	Bank6	1	2	1	2	2	4
	Bank7	1	2	1	2	2	4
	Bank8	1	1	1	2	1	2
GND, GND0 to GND7		12	20	12	22	20	60
NC		4	3	1	0	0	44
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	8/4	18/6	8/4	18/9	18/9	50/25
	Bank1	17/8	34/17	18/9	18/9	34/17	46/23
	Bank2	4/2	20/10	4/2	11/5	20/10	24/12
	Bank3	8/4	12/6	8/4	11/5	12/6	16/8
	Bank4	18/9	32/16	18/9	19/9	32/16	46/23
	Bank5	8/4	14/7	10/5	18/9	17/8	46/23
	Bank6	9/4	26/13	9/4	18/8	26/13	32/16
	Bank7	12/6	20/10	12/6	12/6	20/10	23/11
	Bank8	6/2	14/7	6/2	6/2	14/7	14/7
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0	0
	Bank2 (Right Edge)	1	5	1	4	5	6
	Bank3 (Right Edge)	3	3	3	3	3	4
	Bank4 (Bottom Edge)	0	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0	0
	Bank6 (Left Edge)	2	7	2	6	7	8
	Bank7 (Left Edge)	5	5	5	5	5	5
	Bank8 (Right Edge)	0	0	0	0	0	0

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
L11	L11	PB61B	4	BDQ60	C
T13	T13	PB62A	4	BDQ60	T
R13	R13	PB63A	4	BDQ60	T
VCCIO	VCCIO	VCCIO4	4		
T14	T14	PB62B	4	BDQ60	C
P13	P13	PB63B	4	BDQ60	C
GND	GND	GNDIO4	-		
N12	N12	PB64A	4	VREF2_4/BDQ60	T
M12	M12	PB64B	4	VREF1_4/BDQ60	C
R15	R15	CFG2	8		
N14	N14	CFG1	8		
N13	N13	PROGRAMN	8		
N15	N15	CFG0	8		
P15	P15	PR44B	8	WRITEN	C
L12	L12	INITN	8		
N16	N16	PR43B	8	CSN	C
GND	GND	GNDIO8	-		
R14	R14	CCLK	8		
P14	P14	PR44A	8	CS1N	T
M13	M13	DONE	8		
R16	R16	PR42B	8	D1	C
VCCIO	VCCIO	VCCIO8	8		
M16	M16	PR43A	8	D0/SPIFASTN	T
P16	P16	PR42A	8	D2	T
L15	L15	PR41B	8	D3	C
GND	GND	GNDIO8	-		
L14	L14	PR40A	8	D6	T
L16	L16	PR41A	8	D4	T
L10	L10	PR39B	8	D7/SPID0	C
L13	L13	PR40B	8	D5	C
VCCIO	VCCIO	VCCIO8	8		
K11	K11	PR39A	8	DI/CSSPI0N	T
K14	K14	PR38B	8	DOU/CSON	C
K13	K13	PR38A	8	BUSY/SISPI	T
GND	GND	GNDIO8	-		
K15	K15	PR31B	3	RLM0_GPLL_C_FB_A/RDQ34	C
VCCIO	VCCIO	VCCIO3	3		
K16	K16	PR31A	3	RLM0_GPLL_T_FB_A/RDQ34	T
GND	GND	GNDIO3	-		
J16	J16	PR30B	3	RLM0_GPLL_C_IN_A**/RDQ34	C (LVDS)*
J15	J15	PR30A	3	RLM0_GPLL_T_IN_A**/RDQ34	T (LVDS)*
J14	J14	RLM0_PLLCAP	3		

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
E4	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7	T (LVDS)*
E5	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7	C (LVDS)*
-	-	-			GNDIO7	-		
E3	NC	-			PL4A	7	LDQ8	T (LVDS)*
F4	PL3A	7		T	PL5A	7	LDQ8	T
F3	NC	-			PL4B	7	LDQ8	C (LVDS)*
F5	PL3B	7		C	PL5B	7	LDQ8	C
VCCIO	VCCIO7	7			VCCIO7	7		
E2	PL4A	7		T (LVDS)*	PL6A	7	LDQ8	T (LVDS)*
G6	PL5A	7		T	PL7A	7	LDQ8	T
E1	PL4B	7		C (LVDS)*	PL6B	7	LDQ8	C (LVDS)*
G7	PL5B	7		C	PL7B	7	LDQ8	C
GNDIO	GNDIO7	-			GNDIO7	-		
F1	NC	-			PL9A	7	LDQ8	T
H4	NC	-			PL8A	7	LDQS8	T (LVDS)*
F2	NC	-			PL9B	7	LDQ8	C
-	-	-			VCCIO7	7		
H5	NC	-			PL8B	7	LDQ8	C (LVDS)*
G1	NC	-			PL11A	7	LDQ8	T
G3	NC	-			PL10A	7	LDQ8	T (LVDS)*
G2	NC	-			PL11B	7	LDQ8	C
-	-	-			GNDIO	-		
G4	NC	-			PL10B	7	LDQ8	C (LVDS)*
J4	PL7A	7	LDQ10	T	PL13A	7	LDQ16	T
H1	PL6A	7	LDQ10		PL12A	7	LDQ16	T (LVDS)*
J5	PL7B	7	LDQ10	C	PL13B	7	LDQ16	C
L6	PL9A	7	LDQ10	T	PL15A	7	LDQ16	T
VCCIO	VCCIO7	7			VCCIO7	7		
J2	PL8A	7	LDQ10	T (LVDS)*	PL14A	7	LDQ16	T (LVDS)*
L5	PL9B	7	LDQ10	C	PL15B	7	LDQ16	C
J1	PL8B	7	LDQ10	C (LVDS)*	PL14B	7	LDQ16	C (LVDS)*
K3	PL10A	7	LDQS10	T (LVDS)*	PL16A	7	LDQS16	T (LVDS)*
GNDIO	GNDIO7	-			GNDIO	-		
K4	PL10B	7	LDQ10	C (LVDS)*	PL16B	7	LDQ16	C (LVDS)*
K2	PL11A	7	LDQ10	T	PL17A	7	LDQ16	T
VCCIO	VCCIO7	7			VCCIO7	7		
K1	PL11B	7	LDQ10	C	PL17B	7	LDQ16	C
L4	PL12A	7	LDQ10	T (LVDS)*	PL18A	7	LDQ16	T (LVDS)*
GNDIO	GNDIO7	-			GNDIO	-		
L3	PL12B	7	LDQ10	C (LVDS)*	PL18B	7	LDQ16	C (LVDS)*
L2	PL13A	7	PCLKT7_0/LDQ10	T	PL19A	7	PCLKT7_0/LDQ16	T
L1	PL13B	7	PCLKC7_0/LDQ10	C	PL19B	7	PCLKC7_0/LDQ16	C
M5	PL15A	6	PCLKT6_0	T (LVDS)*	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*
VCCIO	VCCIO6	6			-	-		

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
H16	NC	-			NC	-		
H20	NC	-			NC	-		
H18	NC	-			NC	-		
K6	NC	-			NC	-		
J16	NC	-			NC	-		
N18	VCC	-			VCC	-		
N6	VCC	-			VCC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO5	-			GNDIO5	-		
W10	PB20A	5	BDQ24	T	PB29A	5	BDQ33	T
Y10	PB20B	5	BDQ24	C	PB29B	5	BDQ33	C
W11	PB21A	5	BDQ24	T	PB30A	5	BDQ33	T
AA10	PB21B	5	BDQ24	C	PB30B	5	BDQ33	C
AC8	PB22A	5	BDQ24	T	PB31A	5	BDQ33	T
AD8	PB22B	5	BDQ24	C	PB31B	5	BDQ33	C
VCCIO	VCCIO5	5			VCCIO5	5		
AB8	PB23A	5	BDQ24	T	PB32A	5	BDQ33	T
AB10	PB23B	5	BDQ24	C	PB32B	5	BDQ33	C
GND	GNDIO5	-			GNDIO5	-		
AE6	PB24A	5	BDQS24	T	PB33A	5	BDQS33	T
AF6	PB24B	5	BDQ24	C	PB33B	5	BDQ33	C
AA11	PB25A	5	BDQ24	T	PB34A	5	BDQ33	T
AC9	PB25B	5	BDQ24	C	PB34B	5	BDQ33	C
AB9	PB26A	5	BDQ24	T	PB35A	5	BDQ33	T
AD9	PB26B	5	BDQ24	C	PB35B	5	BDQ33	C
VCCIO	VCCIO5	5			VCCIO5	5		
Y11	PB27A	5	BDQ24	T	PB36A	5	BDQ33	T
AB11	PB27B	5	BDQ24	C	PB36B	5	BDQ33	C
AE7	PB28A	5	BDQ24	T	PB37A	5	BDQ33	T
AF7	PB28B	5	BDQ24	C	PB37B	5	BDQ33	C
GND	GNDIO5	-			GNDIO5	-		
AC10	PB29A	5	BDQ33	T	PB38A	5	BDQ42	T
AD10	PB29B	5	BDQ33	C	PB38B	5	BDQ42	C
AA12	PB30A	5	BDQ33	T	PB39A	5	BDQ42	T
W12	PB30B	5	BDQ33	C	PB39B	5	BDQ42	C
AB12	PB31A	5	BDQ33	T	PB40A	5	BDQ42	T
VCCIO	VCCIO5	5			VCCIO5	5		
Y12	PB31B	5	BDQ33	C	PB40B	5	BDQ42	C
AD12	PB32A	5	BDQ33	T	PB41A	5	BDQ42	T
AC12	PB32B	5	BDQ33	C	PB41B	5	BDQ42	C
AC13	PB33A	5	BDQS33	T	PB42A	5	BDQS42	T
GND	GNDIO5	-			GNDIO5	-		
AA13	PB33B	5	BDQ33	C	PB42B	5	BDQ42	C
AD13	PB34A	5	BDQ33	T	PB43A	5	BDQ42	T
AC14	PB34B	5	BDQ33	C	PB43B	5	BDQ42	C
AE8	PB35A	5	BDQ33	T	PB44A	5	BDQ42	T
VCCIO	VCCIO5	5			VCCIO5	5		
AF8	PB35B	5	BDQ33	C	PB44B	5	BDQ42	C
AB15	PB36A	5	BDQ33	T	PB45A	5	BDQ42	T
Y13	PB36B	5	BDQ33	C	PB45B	5	BDQ42	C
AE9	PB37A	5	BDQ33	T	PB46A	5	BDQ42	T
GND	GNDIO5	-			GNDIO5	-		
AF9	PB37B	5	BDQ33	C	PB46B	5	BDQ42	C
W13	PB38A	5	BDQ42	T	PB47A	5	BDQ51	T

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
C13	GND	-		
C18	GND	-		
C23	GND	-		
C28	GND	-		
C3	GND	-		
C8	GND	-		
H28	GND	-		
H3	GND	-		
L14	GND	-		
L15	GND	-		
L16	GND	-		
L17	GND	-		
M12	GND	-		
M13	GND	-		
M14	GND	-		
M15	GND	-		
M16	GND	-		
M17	GND	-		
M18	GND	-		
M19	GND	-		
N12	GND	-		
N13	GND	-		
N14	GND	-		
N15	GND	-		
N16	GND	-		
N17	GND	-		
N18	GND	-		
N19	GND	-		
N28	GND	-		
N3	GND	-		
P11	GND	-		
P12	GND	-		
P13	GND	-		
P14	GND	-		
P15	GND	-		
P16	GND	-		
P17	GND	-		
P18	GND	-		
P19	GND	-		
P20	GND	-		
R11	GND	-		
R12	GND	-		
R13	GND	-		

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
T7	PB22A	4	PCLKT4_0/BDQ24	T	PB40A	4	PCLKT4_0/BDQ42	T
VCCIO	VCCIO4	4			VCCIO4	4		
T8	PB22B	4	PCLKC4_0/BDQ24	C	PB40B	4	PCLKC4_0/BDQ42	C
L7	PB23A	4	VREF2_4/BDQ24	T	PB41A	4	VREF2_4/BDQ42	T
L8	PB23B	4	VREF1_4/BDQ24	C	PB41B	4	VREF1_4/BDQ42	C
GNDIO	GNDIO4	-			GNDIO4	-		
VCCIO	VCCIO4	4			VCCIO4	4		
GNDIO	GNDIO4	-			GNDIO4	-		
P8	PB29A	4	BDQ33	T	PB47A	4	BDQ51	T
N8	PB29B	4	BDQ33	C	PB47B	4	BDQ51	C
R7	PB30A	4	BDQ33	T	PB48A	4	BDQ51	T
R8	PB30B	4	BDQ33	C	PB48B	4	BDQ51	C
N7	PB31A	4	BDQ33	T	PB49A	4	BDQ51	T
M8	PB31B	4	BDQ33	C	PB49B	4	BDQ51	C
VCCIO	VCCIO4	4			VCCIO4	4		
R9	PB32A	4	BDQ33	T	PB50A	4	BDQ51	T
T9	PB32B	4	BDQ33	C	PB50B	4	BDQ51	C
GNDIO	GNDIO4	-			GNDIO4	-		
T10	PB33A	4	BDQS33	T	PB51A	4	BDQS51	T
R10	PB33B	4	BDQ33	C	PB51B	4	BDQ51	C
N9	PB34A	4	BDQ33	T	PB52A	4	BDQ51	T
P10	PB34B	4	BDQ33	C	PB52B	4	BDQ51	C
VCCIO	VCCIO4	4			VCCIO4	4		
GNDIO	GNDIO4	-			GNDIO4	-		
L9	PB47A	4	BDQ51	T	PB65A	4	BDQ69	T
M9	PB47B	4	BDQ51	C	PB65B	4	BDQ69	C
T11	PB49A	4	BDQ51	T	PB67A	4	BDQ69	T
R11	PB49B	4	BDQ51	C	PB67B	4	BDQ69	C
VCCIO	VCCIO4	4			VCCIO4	4		
T12	PB50A	4	BDQ51	T	PB68A	4	BDQ69	T
T13	PB50B	4	BDQ51	C	PB68B	4	BDQ69	C
GNDIO	GNDIO4	-			GNDIO4	-		
P11	PB51A	4	BDQS51	T	PB69A	4	BDQS69	T
N10	PB51B	4	BDQ51	C	PB69B	4	BDQ69	C
T14	PB52A	4	BDQ51	T	PB70A	4	BDQ69	T
R13	PB52B	4	BDQ51	C	PB70B	4	BDQ69	C
R15	PB53A	4	BDQ51	T	PB71A	4	BDQ69	T
R16	PB53B	4	BDQ51	C	PB71B	4	BDQ69	C
VCCIO	VCCIO4	4			VCCIO4	4		
R14	PB54A	4	BDQ51	T	PB72A	4	BDQ69	T
P15	PB54B	4	BDQ51	C	PB72B	4	BDQ69	C
P16	PB55A	4	BDQ51	T	PB73A	4	BDQ69	T
P14	PB55B	4	BDQ51	C	PB73B	4	BDQ69	C
GNDIO	GNDIO4	-			GNDIO4	-		
L11	CFG2	8			CFG2	8		
L10	CFG1	8			CFG1	8		
P13	CFG0	8			CFG0	8		
N12	PROGRAMN	8			PROGRAMN	8		

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
GNDIO	GNDIO0	-			GNDIO0	-			
F7	PT9B	0		C	PT9B	0		C	
G7	PT9A	0		T	PT9A	0		T	
C3	PT8B	0		C	PT8B	0		C	
D4	PT8A	0		T	PT8A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
F6	PT7B	0		C	PT7B	0		C	
E6	PT7A	0		T	PT7A	0		T	
E5	PT6B	0		C	PT6B	0		C	
D6	PT6A	0		T	PT6A	0		T	
GNDIO	GNDIO0	-			GNDIO0	-			
D3	PT5B	0		C	PT5B	0		C	
E3	PT5A	0		T	PT5A	0		T	
D5	PT4B	0		C	PT4B	0		C	
E4	PT4A	0		T	PT4A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
C2	PT3B	0		C	PT3B	0		C	
B2	PT3A	0		T	PT3A	0		T	
B1	PT2B	0		C	PT2B	0		C	
C1	PT2A	0		T	PT2A	0		T	
R8	VCCPLL	-			VCCPLL	-			
H15	VCCPLL	-			VCCPLL	-			
H8	VCCPLL	-			VCCPLL	-			
R15	VCCPLL	-			VCCPLL	-			
J10	VCC	-			VCC	-			
J11	VCC	-			VCC	-			
J12	VCC	-			VCC	-			
J13	VCC	-			VCC	-			
K14	VCC	-			VCC	-			
K9	VCC	-			VCC	-			
L14	VCC	-			VCC	-			
L9	VCC	-			VCC	-			
M14	VCC	-			VCC	-			
M9	VCC	-			VCC	-			
N14	VCC	-			VCC	-			
N9	VCC	-			VCC	-			
P10	VCC	-			VCC	-			
P11	VCC	-			VCC	-			
P12	VCC	-			VCC	-			
P13	VCC	-			VCC	-			
B5	VCCIO0	0			VCCIO0	0			
B9	VCCIO0	0			VCCIO0	0			
E7	VCCIO0	0			VCCIO0	0			
H9	VCCIO0	0			VCCIO0	0			
D13	VCCIO1	1			VCCIO1	1			
E16	VCCIO1	1			VCCIO1	1			
H14	VCCIO1	1			VCCIO1	1			
E21	VCCIO2	2			VCCIO2	2			

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
T18	VCCAUX	-			VCCAUX	-			
T9	VCCAUX	-			VCCAUX	-			
V11	VCCAUX	-			VCCAUX	-			
V12	VCCAUX	-			VCCAUX	-			
V15	VCCAUX	-			VCCAUX	-			
V16	VCCAUX	-			VCCAUX	-			
A13	GND	-			GND	-			
A19	GND	-			GND	-			
A2	GND	-			GND	-			
A25	GND	-			GND	-			
AA2	GND	-			GND	-			
AA25	GND	-			GND	-			
AB18	GND	-			GND	-			
AB22	GND	-			GND	-			
AB5	GND	-			GND	-			
AB9	GND	-			GND	-			
AE1	GND	-			GND	-			
AE11	GND	-			GND	-			
AE16	GND	-			GND	-			
AE22	GND	-			GND	-			
AE26	GND	-			GND	-			
AE6	GND	-			GND	-			
AF13	GND	-			GND	-			
AF19	GND	-			GND	-			
AF2	GND	-			GND	-			
AF25	GND	-			GND	-			
B1	GND	-			GND	-			
B11	GND	-			GND	-			
B16	GND	-			GND	-			
B22	GND	-			GND	-			
B26	GND	-			GND	-			
B6	GND	-			GND	-			
E18	GND	-			GND	-			
E22	GND	-			GND	-			
E5	GND	-			GND	-			
E9	GND	-			GND	-			
F2	GND	-			GND	-			
F25	GND	-			GND	-			
G11	GND	-			GND	-			
G16	GND	-			GND	-			
J22	GND	-			GND	-			
J5	GND	-			GND	-			
K11	GND	-			GND	-			
K13	GND	-			GND	-			
K14	GND	-			GND	-			
K16	GND	-			GND	-			
L10	GND	-			GND	-			
L11	GND	-			GND	-			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AF17	GND	-			GND	-			
AF25	GND	-			GND	-			
AF6	GND	-			GND	-			
AJ10	GND	-			GND	-			
AJ21	GND	-			GND	-			
AJ27	GND	-			GND	-			
AJ4	GND	-			GND	-			
AK1	GND	-			GND	-			
AK13	GND	-			GND	-			
AK18	GND	-			GND	-			
AK24	GND	-			GND	-			
AK30	GND	-			GND	-			
AK7	GND	-			GND	-			
B10	GND	-			GND	-			
B21	GND	-			GND	-			
B27	GND	-			GND	-			
B4	GND	-			GND	-			
D25	GND	-			GND	-			
D6	GND	-			GND	-			
E14	GND	-			GND	-			
E17	GND	-			GND	-			
F22	GND	-			GND	-			
F27	GND	-			GND	-			
F4	GND	-			GND	-			
F9	GND	-			GND	-			
G12	GND	-			GND	-			
G19	GND	-			GND	-			
J24	GND	-			GND	-			
J7	GND	-			GND	-			
K14	GND	-			GND	-			
K15	GND	-			GND	-			
K16	GND	-			GND	-			
K17	GND	-			GND	-			
K27	GND	-			GND	-			
K4	GND	-			GND	-			
L14	GND	-			GND	-			
L15	GND	-			GND	-			
L16	GND	-			GND	-			
L17	GND	-			GND	-			
M23	GND	-			GND	-			
M8	GND	-			GND	-			
N14	GND	-			GND	-			
N15	GND	-			GND	-			
N16	GND	-			GND	-			
N17	GND	-			GND	-			
N27	GND	-			GND	-			
N4	GND	-			GND	-			
P11	GND	-			GND	-			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AE27	GND	-		
AE4	GND	-		
AE9	GND	-		
AF14	GND	-		
AF17	GND	-		
AF25	GND	-		
AF6	GND	-		
AJ10	GND	-		
AJ21	GND	-		
AJ27	GND	-		
AJ4	GND	-		
AK1	GND	-		
AK13	GND	-		
AK18	GND	-		
AK24	GND	-		
AK30	GND	-		
AK7	GND	-		
B10	GND	-		
B21	GND	-		
B27	GND	-		
B4	GND	-		
D25	GND	-		
D6	GND	-		
E14	GND	-		
E17	GND	-		
F22	GND	-		
F27	GND	-		
F4	GND	-		
F9	GND	-		
G12	GND	-		
G19	GND	-		
J24	GND	-		
J7	GND	-		
K14	GND	-		
K15	GND	-		
K16	GND	-		
K17	GND	-		
K27	GND	-		
K4	GND	-		
L14	GND	-		
L15	GND	-		
L16	GND	-		
L17	GND	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AE23	NC	-		
AE5	NC	-		
AE6	NC	-		
AE7	NC	-		
AF20	NC	-		
AF23	NC	-		
AF5	NC	-		
AG23	NC	-		
AG26	NC	-		
D10	NC	-		
E10	NC	-		
E11	NC	-		
F10	NC	-		
F20	NC	-		
F23	NC	-		
F8	NC	-		
G10	NC	-		
G20	NC	-		
G21	NC	-		
G7	NC	-		
G8	NC	-		
G9	NC	-		
H19	NC	-		
H20	NC	-		
H21	NC	-		
H22	NC	-		
H6	NC	-		
H8	NC	-		
H9	NC	-		
J10	NC	-		
J20	NC	-		
J21	NC	-		
J9	NC	-		
K9	NC	-		
R9	NC	-		
U22	NC	-		
W9	NC	-		
N13	VCCPLL	-		
N18	VCCPLL	-		
V13	VCCPLL	-		

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35E-5FN484C	331	1.2V	-5	Lead-Free fpBGA	484	COM	35
LFE2-35E-6FN484C	331	1.2V	-6	Lead-Free fpBGA	484	COM	35
LFE2-35E-7FN484C	331	1.2V	-7	Lead-Free fpBGA	484	COM	35
LFE2-35E-5FN672C	450	1.2V	-5	Lead-Free fpBGA	672	COM	35
LFE2-35E-6FN672C	450	1.2V	-6	Lead-Free fpBGA	672	COM	35
LFE2-35E-7FN672C	450	1.2V	-7	Lead-Free fpBGA	672	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50E-5FN484C	339	1.2V	-5	Lead-Free fpBGA	484	COM	50
LFE2-50E-6FN484C	339	1.2V	-6	Lead-Free fpBGA	484	COM	50
LFE2-50E-7FN484C	339	1.2V	-7	Lead-Free fpBGA	484	COM	50
LFE2-50E-5FN672C	500	1.2V	-5	Lead-Free fpBGA	672	COM	50
LFE2-50E-6FN672C	500	1.2V	-6	Lead-Free fpBGA	672	COM	50
LFE2-50E-7FN672C	500	1.2V	-7	Lead-Free fpBGA	672	COM	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70E-5FN672C	500	1.2V	-5	Lead-Free fpBGA	672	COM	70
LFE2-70E-6FN672C	500	1.2V	-6	Lead-Free fpBGA	672	COM	70
LFE2-70E-7FN672C	500	1.2V	-7	Lead-Free fpBGA	672	COM	70
LFE2-70E-5FN900C	583	1.2V	-5	Lead-Free fpBGA	900	COM	70
LFE2-70E-6FN900C	583	1.2V	-6	Lead-Free fpBGA	900	COM	70
LFE2-70E-7FN900C	583	1.2V	-7	Lead-Free fpBGA	900	COM	70

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5TN144I	90	1.2V	-5	Lead-Free TQFP	144	IND	6
LFE2-6E-6TN144I	90	1.2V	-6	Lead-Free TQFP	144	IND	6
LFE2-6E-5FN256I	190	1.2V	-5	Lead-Free fpBGA	256	IND	6
LFE2-6E-6FN256I	190	1.2V	-6	Lead-Free fpBGA	256	IND	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5TN144I	93	1.2V	-5	Lead-Free TQFP	144	IND	12
LFE2-12E-6TN144I	93	1.2V	-6	Lead-Free TQFP	144	IND	12
LFE2-12E-5QN208I	131	1.2V	-5	Lead-Free PQFP	208	IND	12
LFE2-12E-6QN208I	131	1.2V	-6	Lead-Free PQFP	208	IND	12
LFE2-12E-5FN256I	193	1.2V	-5	Lead-Free fpBGA	256	IND	12
LFE2-12E-6FN256I	193	1.2V	-6	Lead-Free fpBGA	256	IND	12
LFE2-12E-5FN484I	297	1.2V	-5	Lead-Free fpBGA	484	IND	12
LFE2-12E-6FN484I	297	1.2V	-6	Lead-Free fpBGA	484	IND	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35SE-5FN484C	331	1.2V	-5	Lead-Free fpBGA	484	Com	35
LFE2-35SE-6FN484C	331	1.2V	-6	Lead-Free fpBGA	484	Com	35
LFE2-35SE-7FN484C	331	1.2V	-7	Lead-Free fpBGA	484	Com	35
LFE2-35SE-5FN672C	450	1.2V	-5	Lead-Free fpBGA	672	Com	35
LFE2-35SE-6FN672C	450	1.2V	-6	Lead-Free fpBGA	672	Com	35
LFE2-35SE-7FN672C	450	1.2V	-7	Lead-Free fpBGA	672	Com	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50SE-5FN484C	339	1.2V	-5	Lead-Free fpBGA	484	Com	50
LFE2-50SE-6FN484C	339	1.2V	-6	Lead-Free fpBGA	484	Com	50
LFE2-50SE-7FN484C	339	1.2V	-7	Lead-Free fpBGA	484	Com	50
LFE2-50SE-5FN672C	500	1.2V	-5	Lead-Free fpBGA	672	Com	50
LFE2-50SE-6FN672C	500	1.2V	-6	Lead-Free fpBGA	672	Com	50
LFE2-50SE-7FN672C	500	1.2V	-7	Lead-Free fpBGA	672	Com	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70SE-5FN672C	500	1.2V	-5	Lead-Free fpBGA	672	Com	70
LFE2-70SE-6FN672C	500	1.2V	-6	Lead-Free fpBGA	672	Com	70
LFE2-70SE-7FN672C	500	1.2V	-7	Lead-Free fpBGA	672	Com	70
LFE2-70SE-5FN900C	583	1.2V	-5	Lead-Free fpBGA	900	Com	70
LFE2-70SE-6FN900C	583	1.2V	-6	Lead-Free fpBGA	900	Com	70
LFE2-70SE-7FN900C	583	1.2V	-7	Lead-Free fpBGA	900	Com	70

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6SE-5TN144I	90	1.2V	-5	Lead-Free TQFP	144	Ind	6
LFE2-6SE-6TN144I	90	1.2V	-6	Lead-Free TQFP	144	Ind	6
LFE2-6SE-5FN256I	190	1.2V	-5	Lead-Free fpBGA	256	Ind	6
LFE2-6SE-6FN256I	190	1.2V	-6	Lead-Free fpBGA	256	Ind	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12SE-5TN144I	93	1.2V	-5	Lead-Free TQFP	144	Ind	12
LFE2-12SE-6TN144I	93	1.2V	-6	Lead-Free TQFP	144	Ind	12
LFE2-12SE-5QN208I	131	1.2V	-5	Lead-Free PQFP	208	Ind	12
LFE2-12SE-6QN208I	131	1.2V	-6	Lead-Free PQFP	208	Ind	12
LFE2-12SE-5FN256I	193	1.2V	-5	Lead-Free fpBGA	256	Ind	12
LFE2-12SE-6FN256I	193	1.2V	-6	Lead-Free fpBGA	256	Ind	12
LFE2-12SE-5FN484I	297	1.2V	-5	Lead-Free fpBGA	484	Ind	12
LFE2-12SE-6FN484I	297	1.2V	-6	Lead-Free fpBGA	484	Ind	12

Date	Version	Section	Change Summary
August 2007 (cont.)	02.8 (cont.)	DC and Switching (cont.)	sysCLOCK GPLL timing has been updated.
		Pinout Information	Added ECP2M50 (484/672/900-fpBGA), ECP2M70 (900-fpBGA) and ECP2M100 (900-fpBGA) pinout information.
		Ordering Information	1156-fpBGA package option has been removed from the LatticeECP2M family.
September 2007	02.9	Pinout Information	Added Thermal Management text section.
February 2008	03.0	Architecture	Added LVCMOS33D description.
		DC and Switching	LatticeECP2M Supply Current has been updated.
			Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLL Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.11).
			Figure 3-9. Read/Write Mode (Normal) and Figure 3-10. Read/Write Mode with Input and Output Registers have been updated.
			Table 3-8. Channel output Jitter (Max) has been updated.
		Pinout Information	Signal description has been updated.
April 2008	03.1	Pinout Information	Added 1152-fpBGA pinouts for the ECP2M70 and ECP2M100.
June 2008	03.2	Pinout Information	Available DDR Interfaces per I/O Bank for the LFE2M35 (484/672-fpBGA) have been updated.
		Introduction	Family Selection Guide table - Updated number of EBR SRAM Blocks for the ECP2-70 device.
		Architecture	Removed Read-Before-Write sysMEM EBR mode.
		Architecture	Clarification of the operation of the secondary clock regions.
August 2008	03.3	DC and Switching Characteristics	Removed Read-Before-Write sysMEM EBR mode.
		Architecture	Clarification of the operation of the secondary clock regions.
		Pinout Information	Added information for [LOC]DQ[num] to Signal Descriptions table.
January 2009	03.4	DC and Switching Characteristics	Updated typical and max. jitter numbers in Channel Output Jitter table for x10 mode.
			Added Channel Output Jitter table for x20 mode.
November 2009	03.5	DC and Switching Characteristics	Updated SPI/SPI _m Configuration Waveforms diagram.
			Updated footnotes in LatticeECP2 Initialization Supply Current table.
			Updated footnotes in LatticeECP2M Initialization Supply Current table.
			Updated footnotes in SERDES High Speed Data Receiver (LatticeECP2M Family Only) table.
			Updated max. value for t _{DINIT} parameter in LatticeECP2/M sysCONFIG Port Timing Specifications table.
			Updated Serial Output Timing and Levels table.
			Updated Figure 3-5 MLVDS
			Updated Table 3-7 Serial Output Timing and Levels
			Updated Table 3-15 Power Down/Power Up Specification
		Pinout Information	Signal Descriptions table - corrected references to ULM, URM, LRM (changed to LUM, RUM and RLM), added footnote 5.